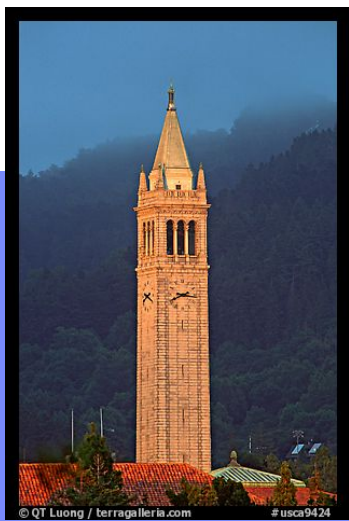




Packaging of New Servers - energy efficiency aspects -

**Roger Schmidt, IBM Fellow
Chief Engineer, Data Center Energy Efficiency**

Many slides provided by Ed Seminaro
Chief Architect of HPC Power6 & 7



1st Berkeley Symposium on Energy Efficient Electronics, June 11 -12, 2009

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Agenda

- ✓ Liquid cooling
- ✓ Power6 packaging
- ✓ Power7 packaging
- ✓ Data Center issues

Back to the future - Rear Door Heat Exchanger

Leveraging Mainframe Heritage

Capabilities

- A water-cooled, heat exchanger designed to remove heat generated from the back of your computer systems before it enters the room
- Patented “rear heat exchanger” can reduce heat at the source
- Utilizes chilled water to dissipate heat generated by computer systems while requiring no additional fans or electricity!

Customer Benefits

- Increase server density without increasing cooling requirements.
- Effective solution for a data center wishing to deal with computer room “hot spots,” or is at the limit of its cooling capacity, but still has useable floor space to add racks of systems.

Water cooling is 3500x more energy efficient than air



IBM uses it today in System x, iDataplex and System p

Processor Liquid Cooling for Increased Performance

System z10 EC is cost effective and can help you **Go Green** by delivering highly **energy efficient technologies**

Customer Benefits

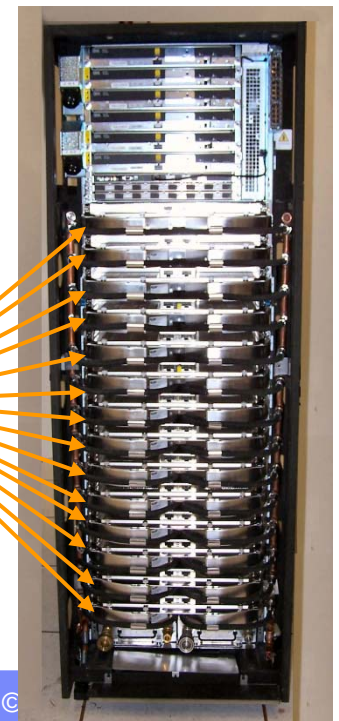
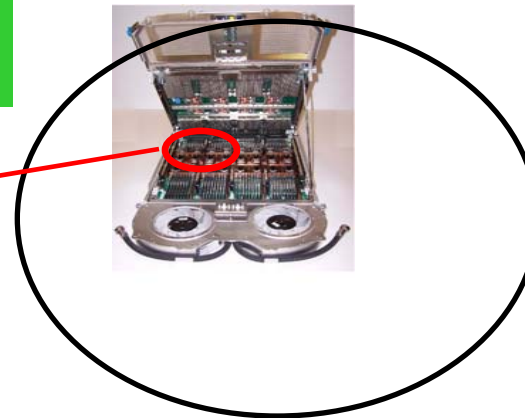
- Highest server utilization
- High performance per watt
- Extremely efficient power and cooling



Power 575 turns on the water for **Green Supercomputer**

Customer Benefits

- 80% heat load to water
- 40% energy savings via improved cooling and power efficiencies
- Up to 8. trillion floating point operations per second + 3.58 TB of memory in a single rack





Today's IBM Mainframe - z10EC

Internal Batteries (optional)

Power Supplies

2 x Support Elements

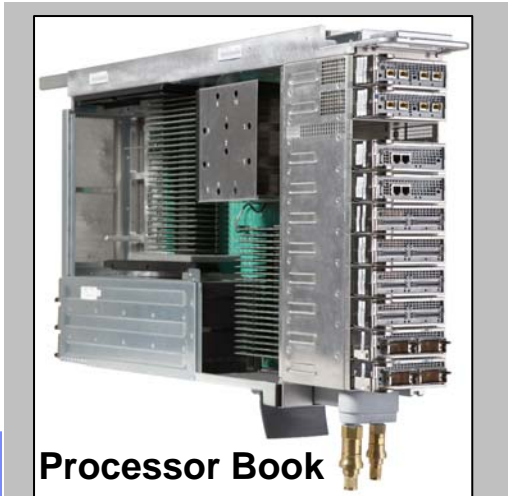
3x I/O cages

Processor Books, Memory, MBA and HCA cards

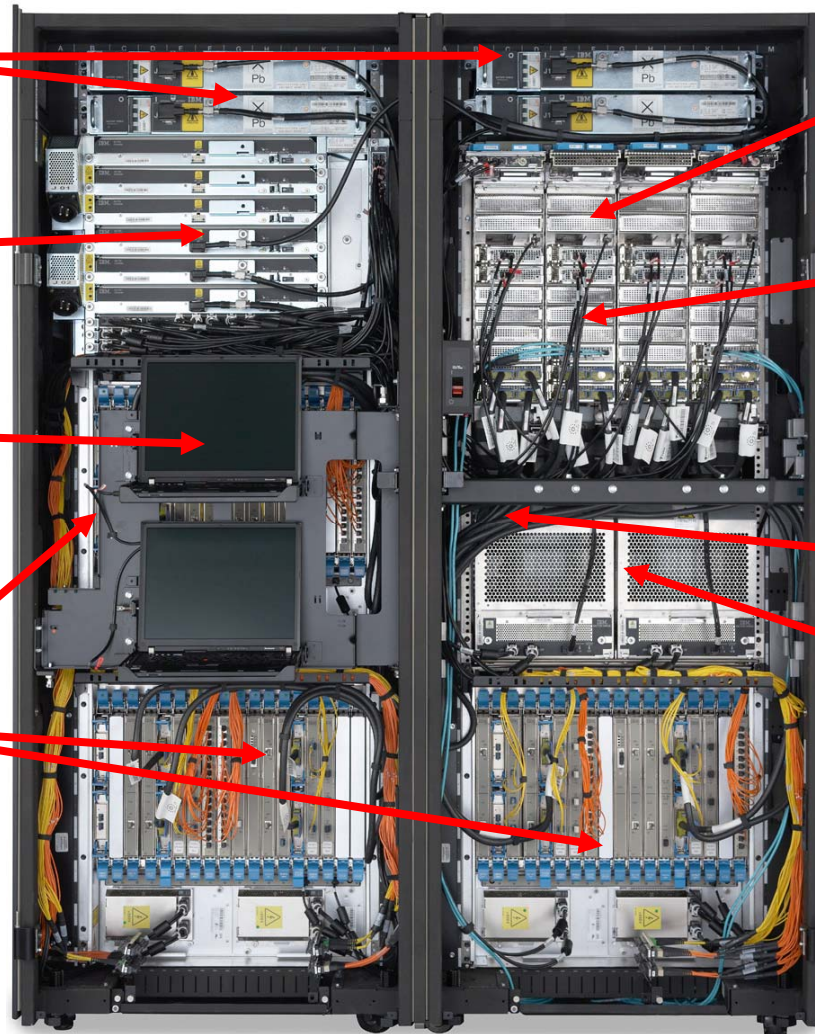
Ethernet cables for internal System LAN connecting Flexible Service Processor (FSP) cage controller cards

InfiniBand I/O Interconnects

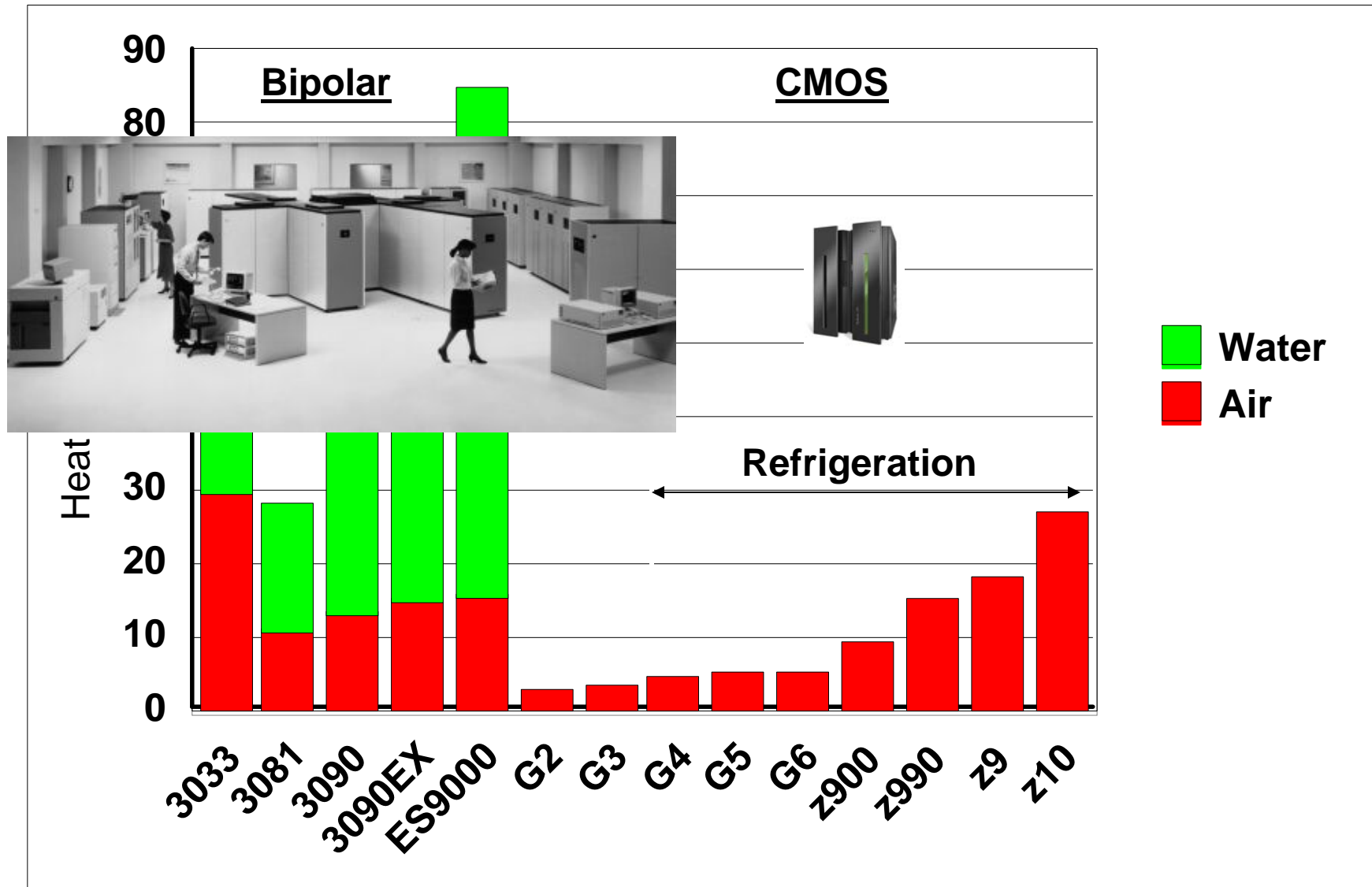
2 x Cooling Units



Processor Book



System Heat Load Trends 1977 - present



IBM Computer Platforms

Focus of Talk = System-p

- System-x Servers
- DS3K/4K Midsize Storage
 - x86 uP & chip set
 - Linux & Windows OS's
 - Industry Standard Interconnect
 - Key Competitors: HP, Dell, etc.
 - Principal DE site: Raleigh, NC

- System-pi Servers
- System-z Mainframes
- DS8K High-End Storage
 - System-pi: "Power uP" based
 - DS8K: "Power uP" based
 - IBM chip set
 - AIX, Linux, I5 OS's, IBM FW
 - Industry Standard Interconnect
 - Competitors: HP, Sun, Cray, SGI
EMC, Hitachi, etc.
 - Principal DE sites: Austin, Tx.
MHV, N.Y.
Rochester, Mn.
Tucson, Az.
- System-z: "370 uP" based
 - IBM chip set throughout
 - IBM cluster interconnect
 - Key Competitors: HP, Sun, etc.
 - Principal DE site: MHV, N.Y.

- Blue Gene System
- Cell Blade
 - Special Purpose HPC
 - BG: "Power uP" based
 - Cell: "Power uP & SPU" based
 - Customized Interconnect
 - Competitors: Cray, etc.
 - Princ DE site: Yorktown, N.Y.
Rochester, Mn

IBM Power Server Systems™



(Shown without lids and heat sinks)

	Blade JS2x	520 HV	550 & 560 HV8	570 L4 / ML	575 IH	595 HE
P5 Systems						
P6 Systems (Transition to organic for some systems)						

The Following Slides Describe the P6 Power 575 High Density Mainstream HPC Server

**Announced at SC07
Began Shipping to Customers in 1H08**

We went all out on the Power-575 to create an Extreme Server that represents the future of Energy efficient Mid-to-Large Scale Technical or Commercial Compute Intense processing Today

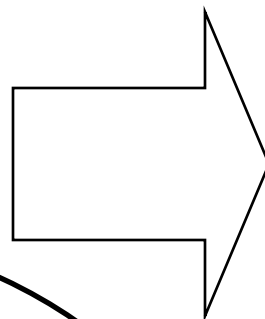
- It has a system structure that eliminates large amounts of unnecessary components
- The rack is directly customer chilled water cooled eliminating most customer on-floor cooling requirements
- The processor is directly water cooled, which reduces its operating temperature and therefore power draw
- It packs 2.5x the compute power of a full rack of blade centers into a single cabinet with very flexible I/O
- It combines the advantages of a large 32w SMP with the cost effectiveness of smaller 4w servers

**UI NCSA Blue Waters is based
on the P7 Follow-on Product to P6/Power-575**

P6-p575

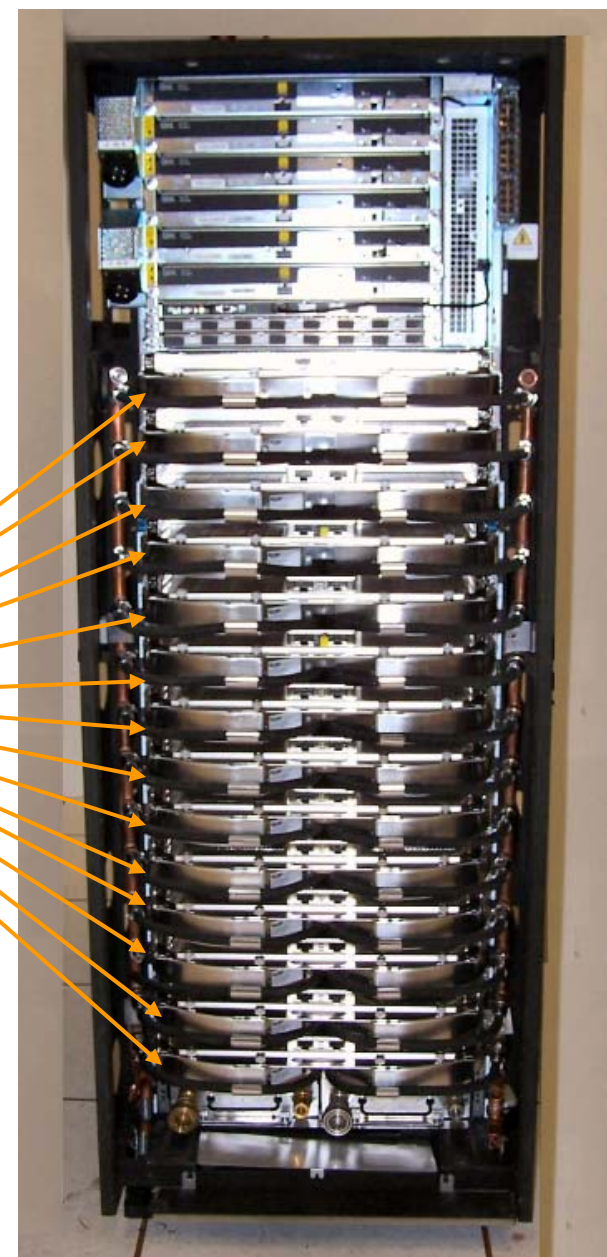
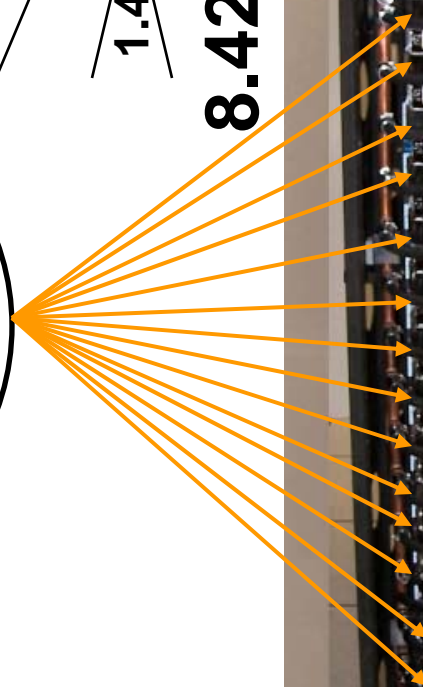
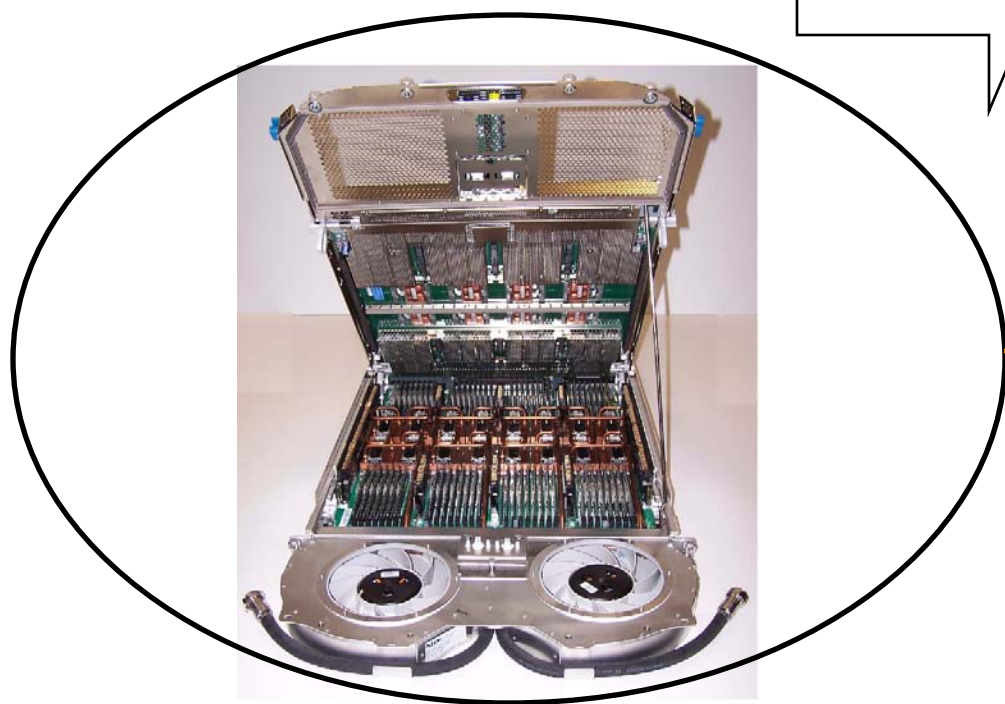
~~121.6 GFLOPs~~

602 GFLOPs



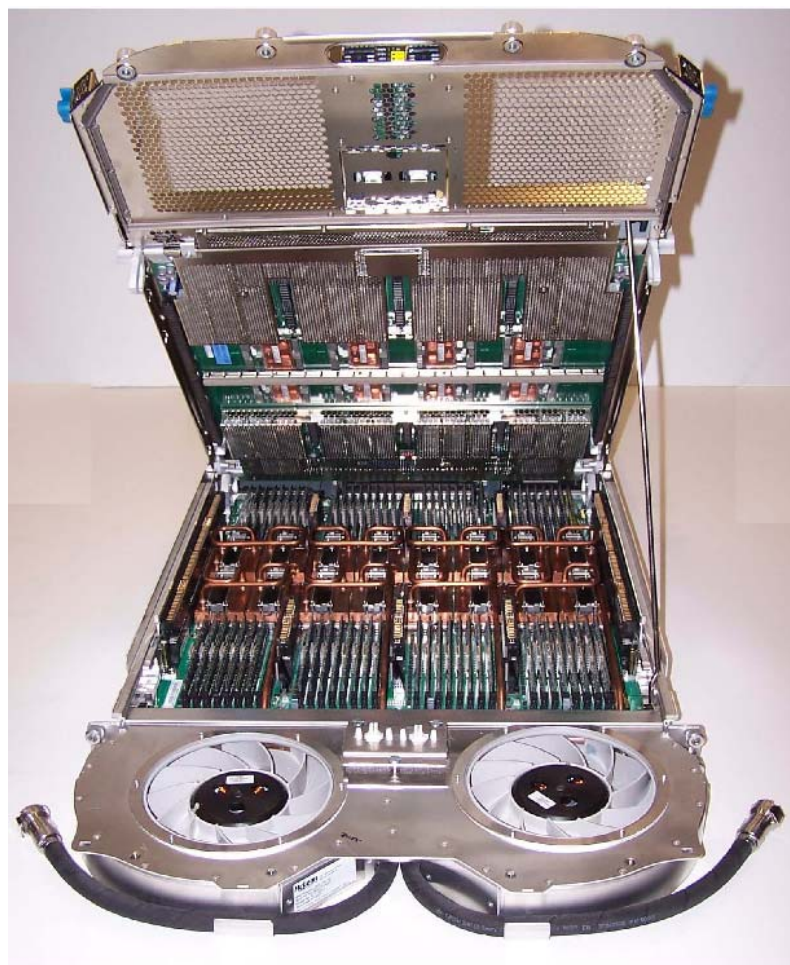
~~1.46 TFLOPs~~

8.42 TFLOPs



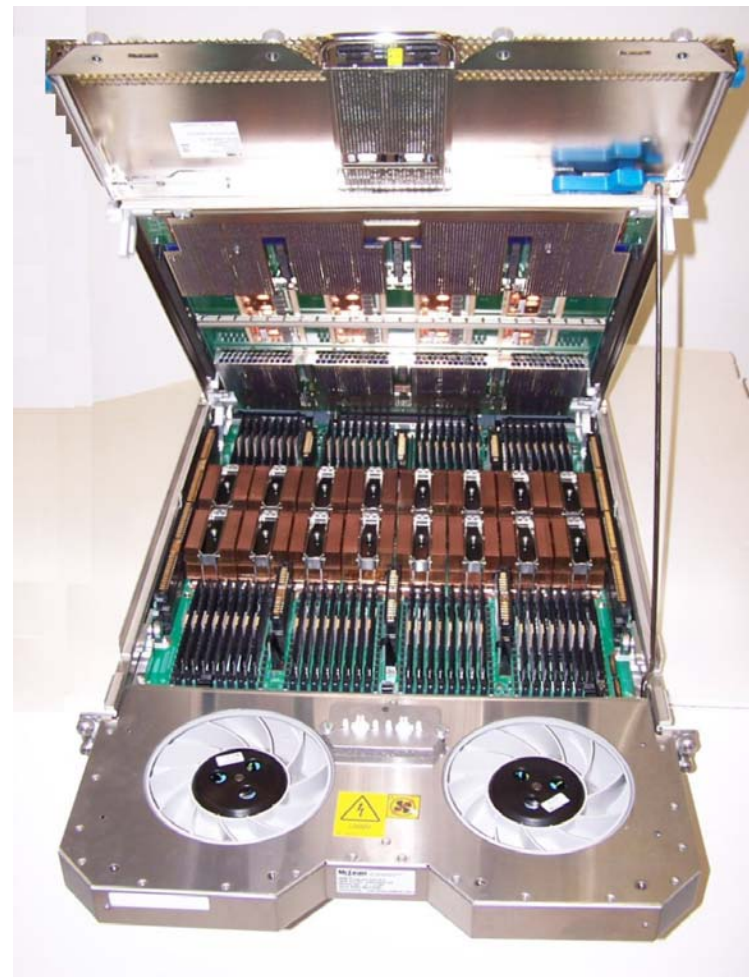
Water Cooled

32W @ 4.7GHz

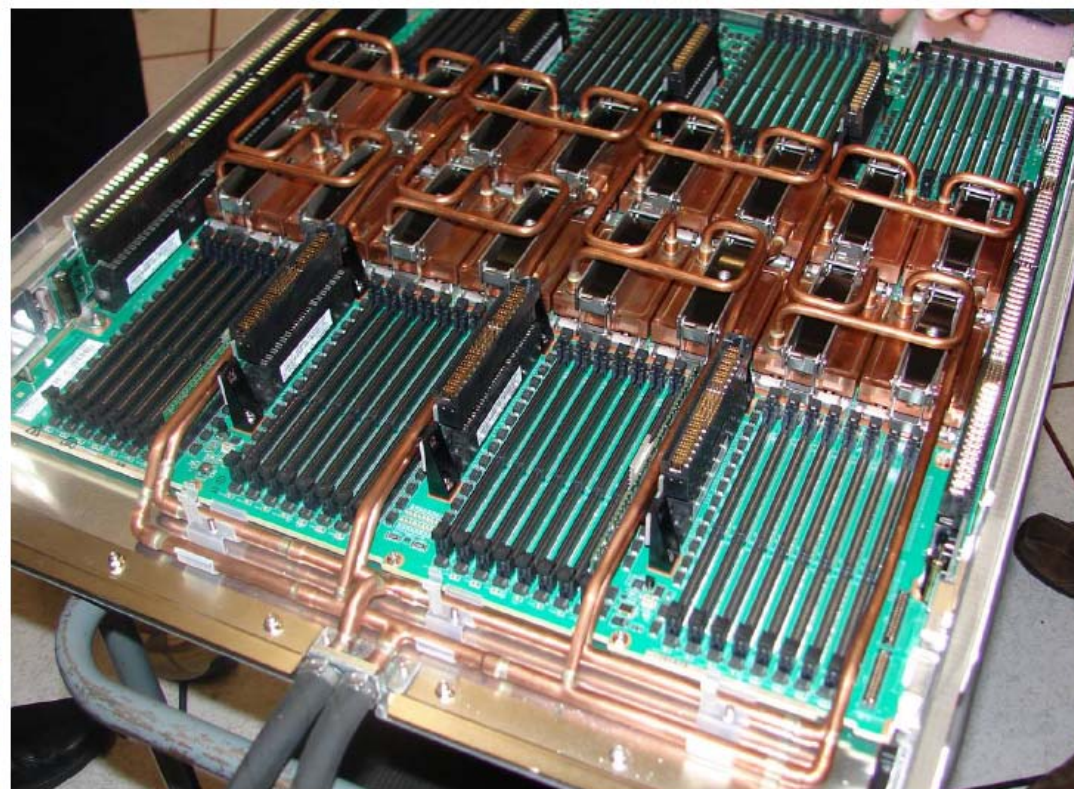
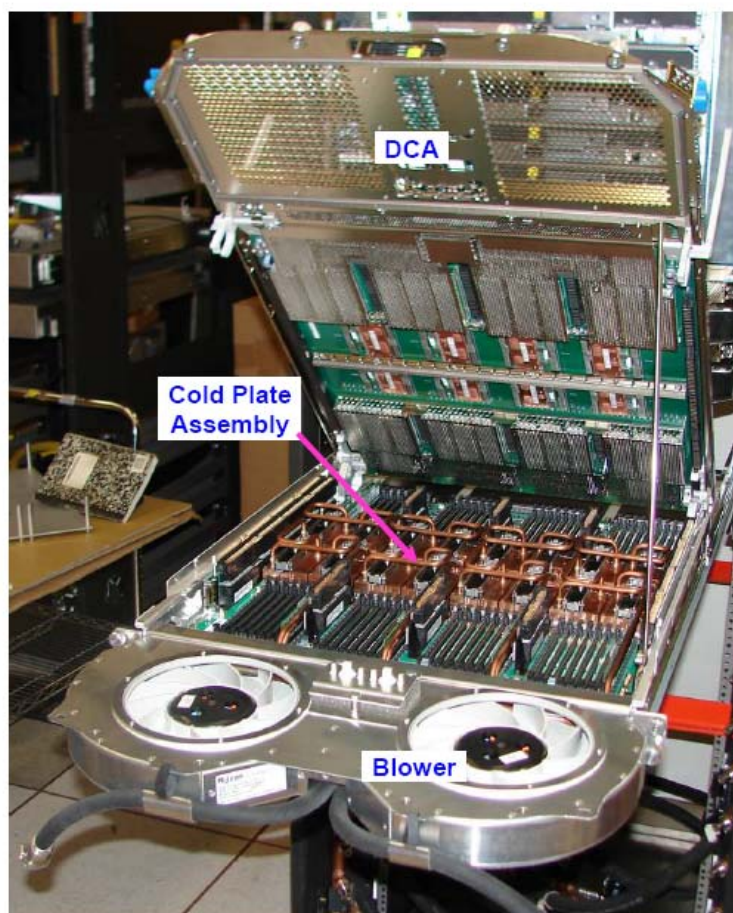


Air Cooled

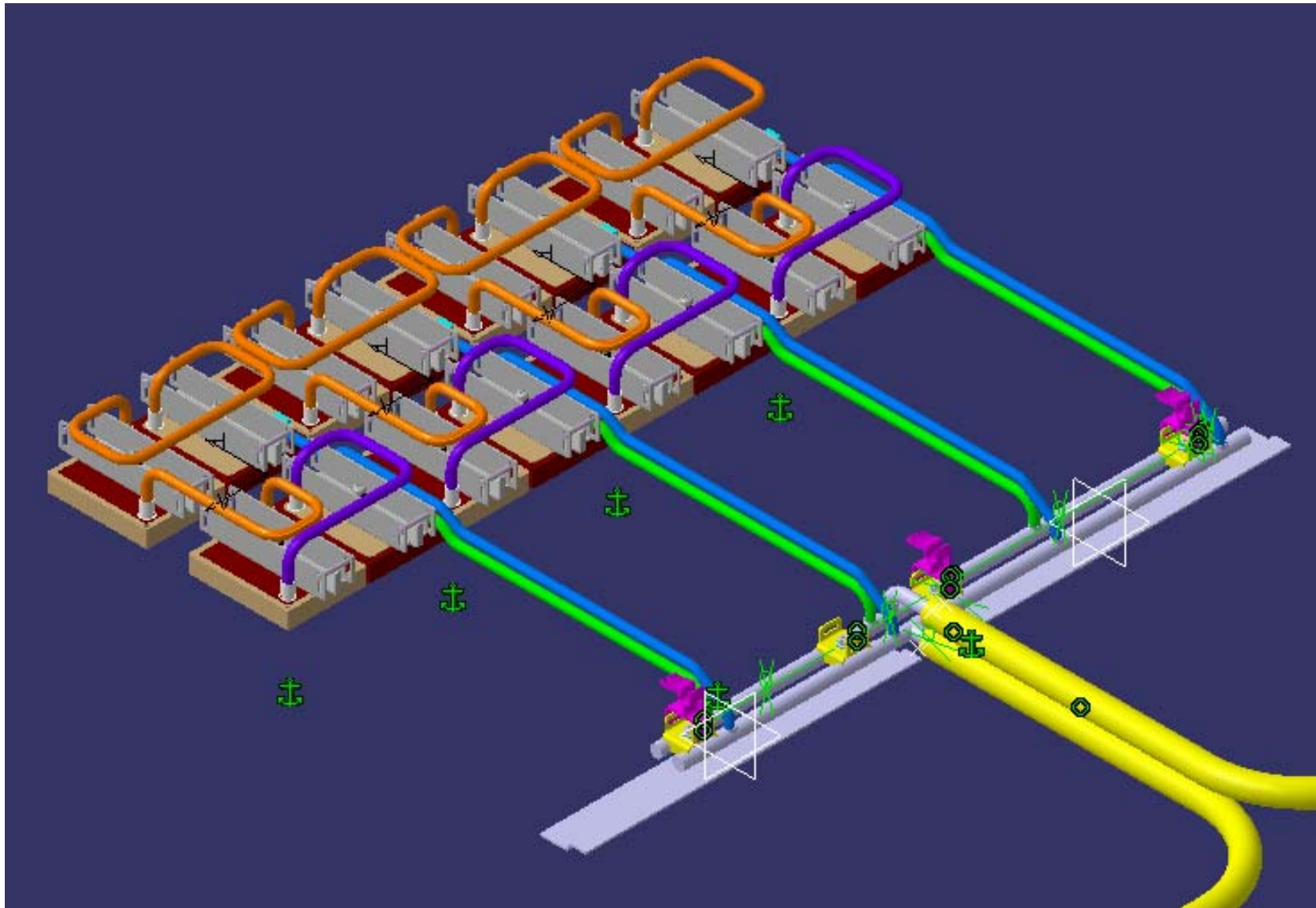
32W @ 3.5GHz



Assembled Node

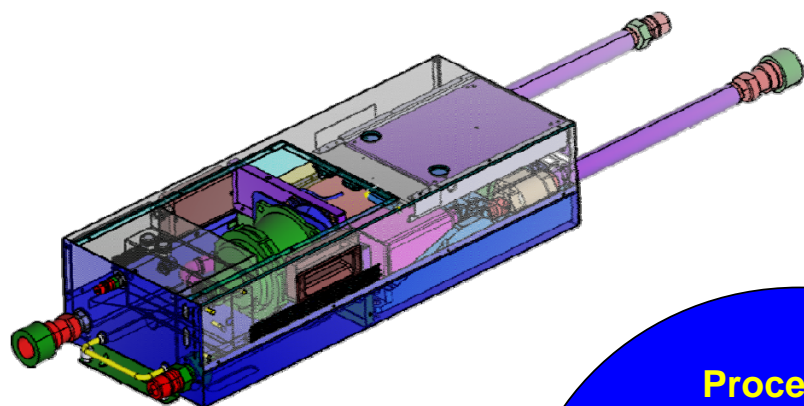


Water Cooled Cold Plate

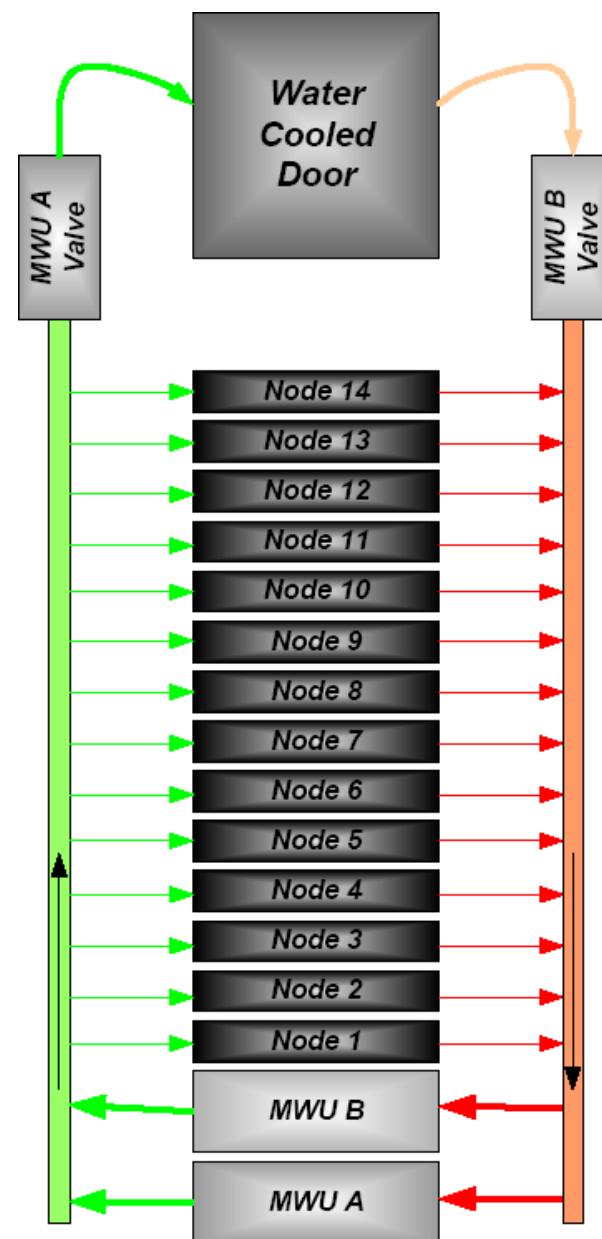
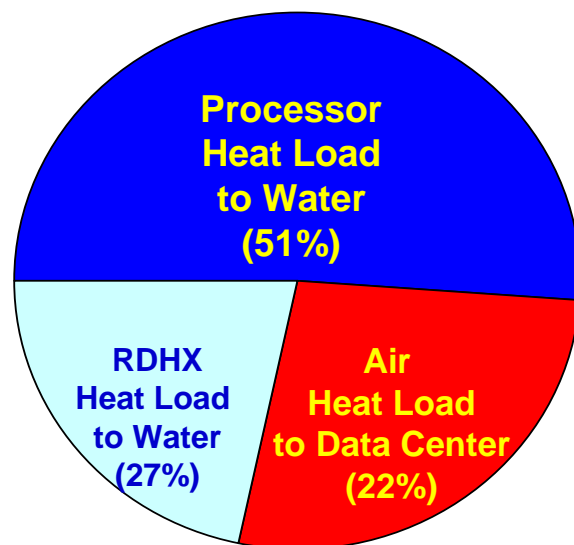


Secondary Loop

- A Single WCU can Cool all 14 Nodes
- WCU's are in parallel
- Each WCU has a door control Valve
- Door is removed from loop if temperature can't be maintained

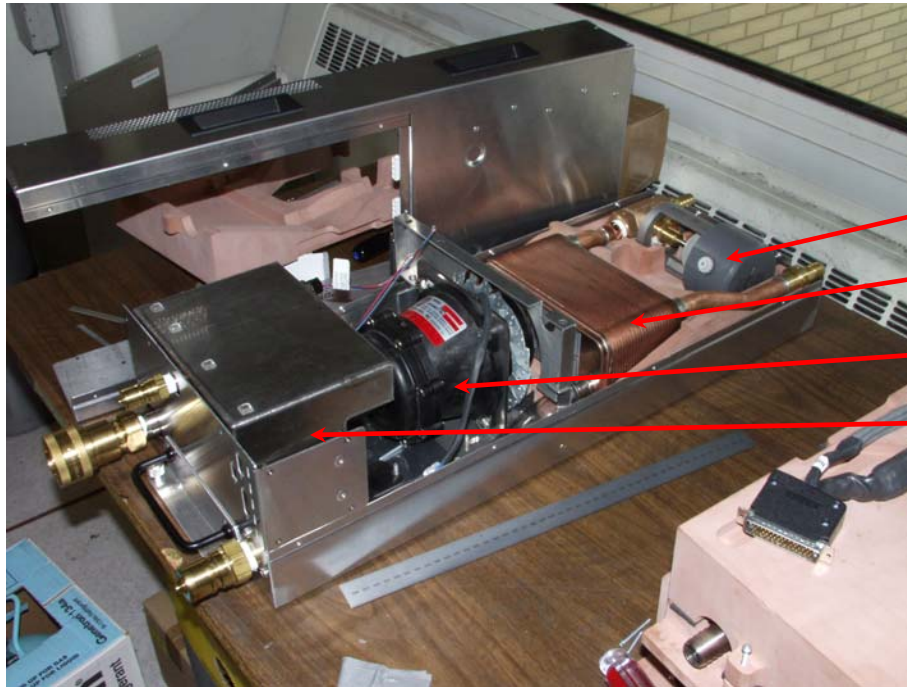


WCU



WCU (Water Conditioning Unit)

- ✓4U Tall by Half of a 24" Rack Unit
- ✓Contains Control Valve, Heat Exchanger, Pump, Reservoir, Sensors, Motor Drive & Interface/Control Card

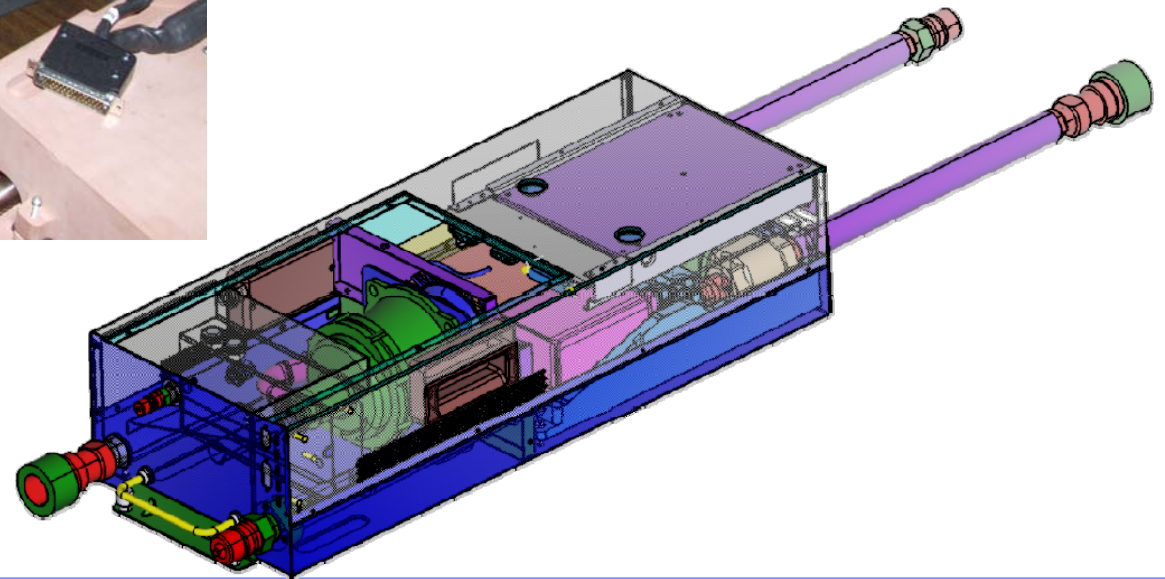


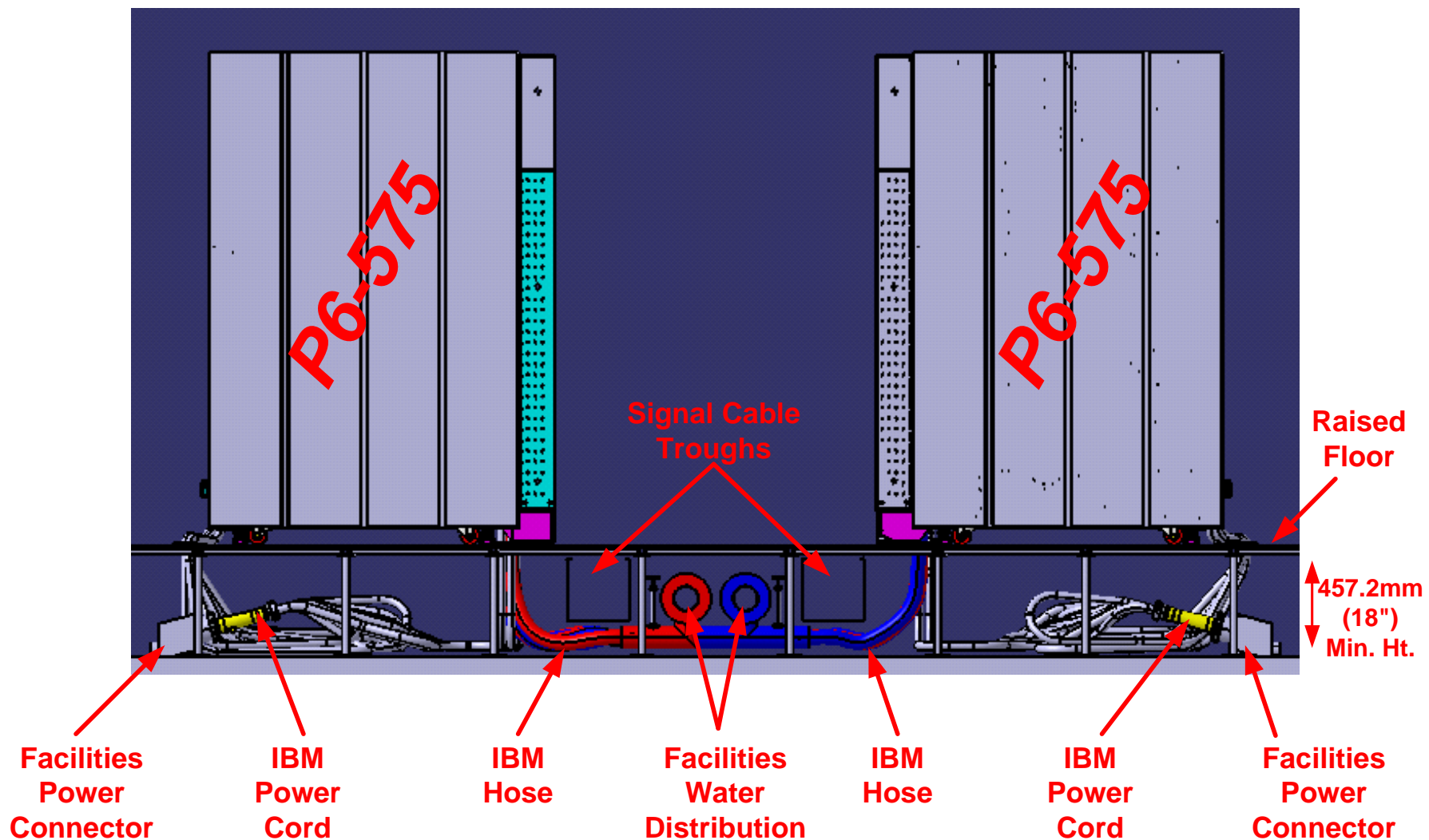
Control Valve

Heat Exchanger

Pump

Reservoir



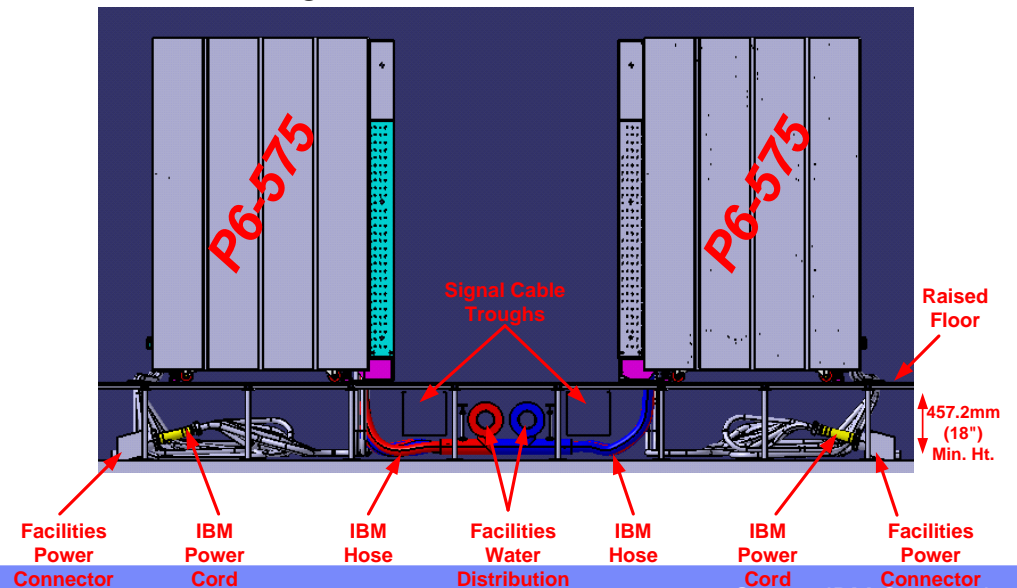


The Power6 575: How We Designed it for Energy Efficiency

Create an Energy Efficient Solution

➤ Maximize the Energy Efficiency of the Data Center Power & Cooling Infrastructure

- Power 575's Power and Cooling Input Enables High Data Center Facility efficiency
 - 480 VAC balanced 3-phase direct power connection – with line cord redundancy
 - PDU step-down losses eliminated
 - Lower building distribution losses and smaller wire sizes
 - In environments that do not require Battery Back-up facility efficiency can be 98% with 480VAC
 - Outstanding Power Line Disturbance Immunity of the Power-575 makes this mode very viable
 - 100% single phase line disturbance immunity
 - Protection against Under-voltages of up to 70%
 - Exceptional protection against Over-Voltage conditions (Line Overshoot, lightning strike, ring)
 - Direct building chilled water connection – with full redundancy
 - Saves on the order of 20% energy over conventional air cooling
 - Eliminates CRAC hardware on the floor
 - Enables tight packing of server racks
 - Without a room temperature penalty



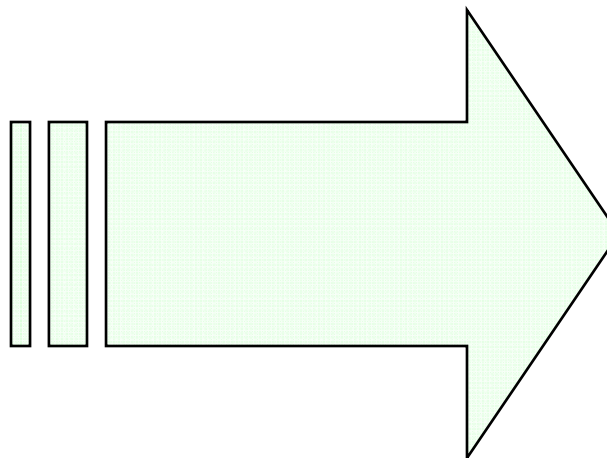
P5-P575
12 Node / 2 Switch **~35 KW max**

~85 KW max

P6-P575
14 Node / 2 WCU



~6x Density of P6 Rack Servers
 ~3x Density of P6 Blade Servers



- Footprint 137 Racks / 100TF (ASCI Purple)
- 0.73 TFlops / Rack
- 45 mW / MFlop
- 100% Thermal Load to Air
- 6 Node Line Cord Redundancy

Same size Rack

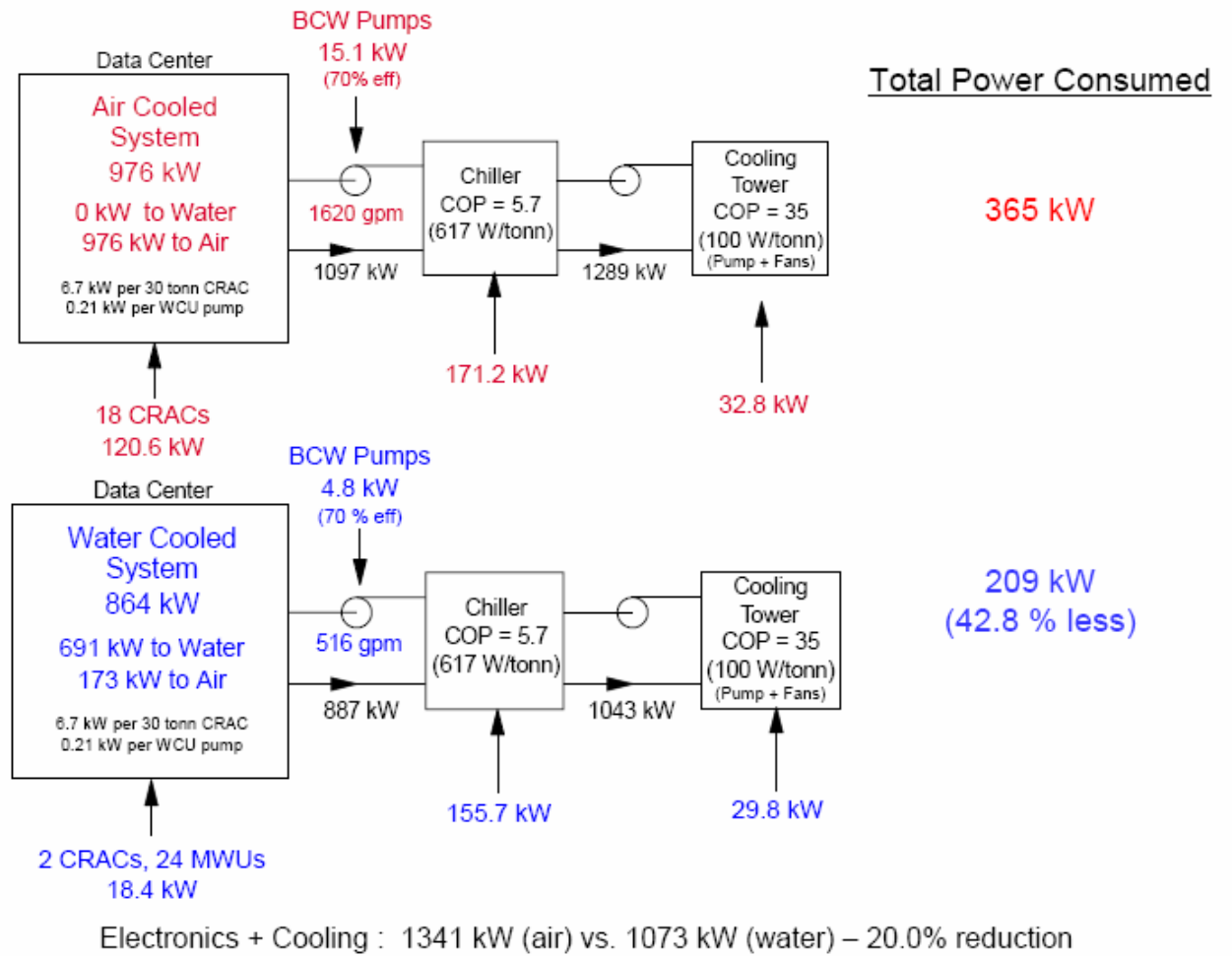
- < 1/10th space
- < 1/5th power
- ~ 1/6th energy
- Footprint 12 Racks / 100TF (ASCI Purple)
- 8.4 TFlops / Rack
- 8 mW / MFlop
- 80% Thermal Load to H²O / 20% to Air
- (10% Cost Savings minimum)
- 14 Node Line Cord Redundancy

P6 575 - Air vs Water



	Air Cooled System	Water Cooled System
Number of Racks	16	12
Total Electronics Power	976 kW	864 kW

Cooling Energy Consumption in the Data Center: Air Cooling vs. Water Cooling



Customer Benefits

- 80% heat load to water
- 40% energy savings via improved cooling and power efficiencies

Systems on the Horizon

- Sequoia-system developed and manufactured by IBM will be installed at LLNL and will start running in 2012. It will have 1.6 Million Power-Processors and 1.6 Pbytes of main memory leading to a peak performance of more than 20 Pflops
- Blue Waters at U. of Illinois/NCSA -The Blue Waters project will provide a computational system capable of sustained petaflop performance on a range of science and engineering applications. The system is built by IBM on the Power7 processor

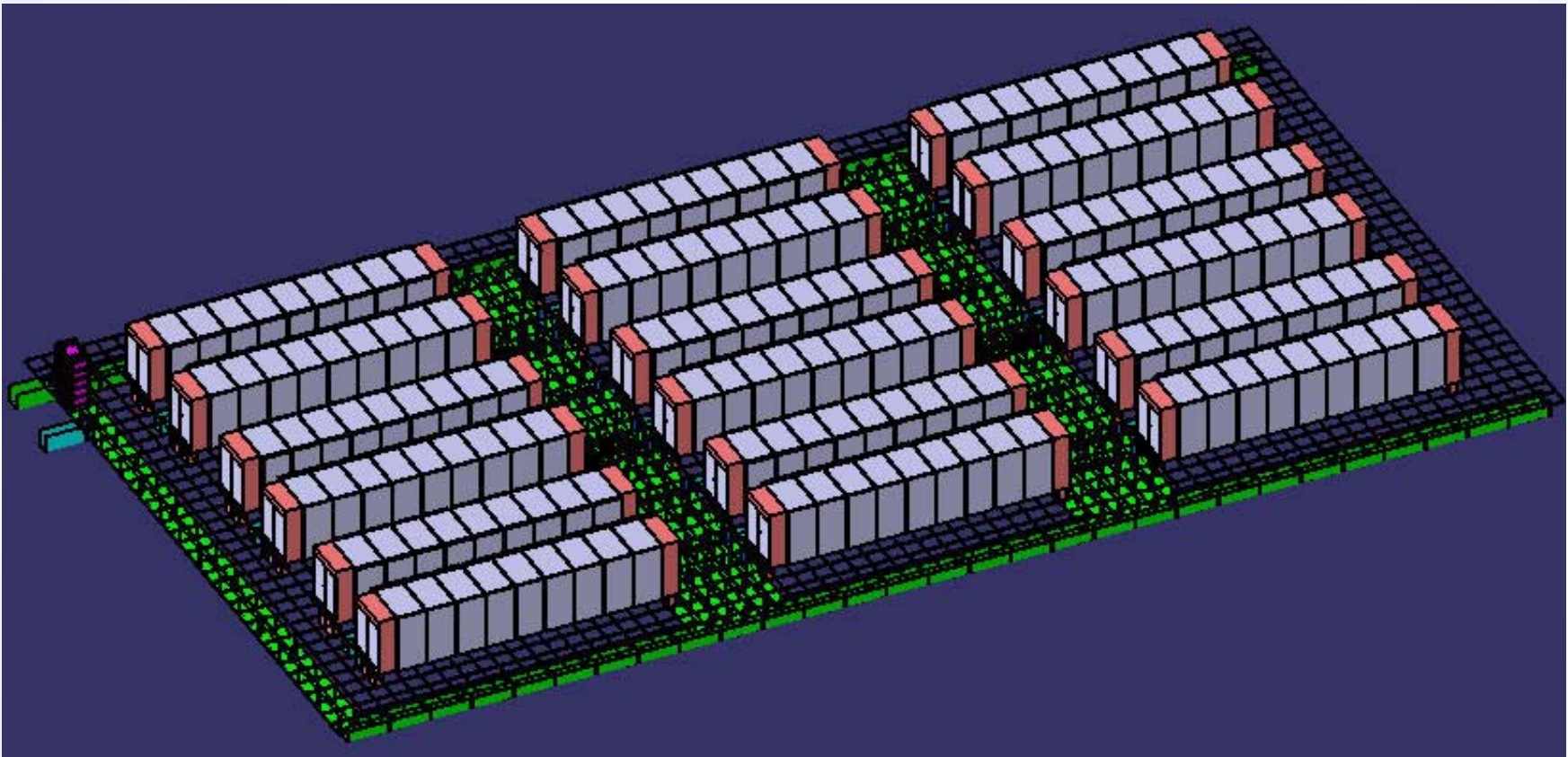
U. Of Illinois/NCSA Green Data Center



Blue Waters will be an unsurpassed national asset, delivering sustained performance of 1 petaflop (that's 1 quadrillion calculations every second) for many science and engineering applications that researchers use every day—not just benchmarks. Blue Waters is being developed and built with a \$208 million grant from the National Science Foundation and will be a resource for scientists and engineers across the country.

Blue Waters will deploy IBM's POWER7 architecture, which is based on advanced multicore processor technology.

UI-NCSA Blue Waters Computing System & the Supporting Facilities Infrastructure



Data Center Efficiency

- Minimize Power Consumption and Floor-space of IT Equipment
 - Servers
 - Storage
 - Networking

- Maximize Efficiency of Data Center Power & Cooling Infrastructure
 - Power Conversion & Distribution from 13KV Building Input to Equipment Input
 - Efficiency of Computer Room Heat Removal
 - Power Required to Remove each KW of Heat from the Room
 - High Availability Design of infrastructure
 - Minimize Waste of Floor Space

Potential Future Directions to Improve Data Center Efficiency

- Move to More Integrated Large Scale IT Equipment
 - Integrate the Network into the Server
 - Unify Storage & Servers
 - Eliminate unnecessary Data Flow & Protocol Conversions that Burn Power
 - Integration Reduces IT Equipment hardware content yielding better reliability, lower cost, & potentially better performance.

Potential Future Directions to Improve Data Center Efficiency

- Improve Heat Transfer from Electronic Components in IT Equipment to the Outside Ambient Environment
 - Direct Water Cooling of Electronic Components
 - Transfer of Heat Load from IT Equipment Cabinets to Outside Air via Water with the Highest Possible Temperature (15 deg-C / 60 deg-F target)
 - Eliminate the majority of Room Level Air Cooling Needs, and provide the air conditioning needed via Air-to-Water Heat Exchange in the IT Equipment

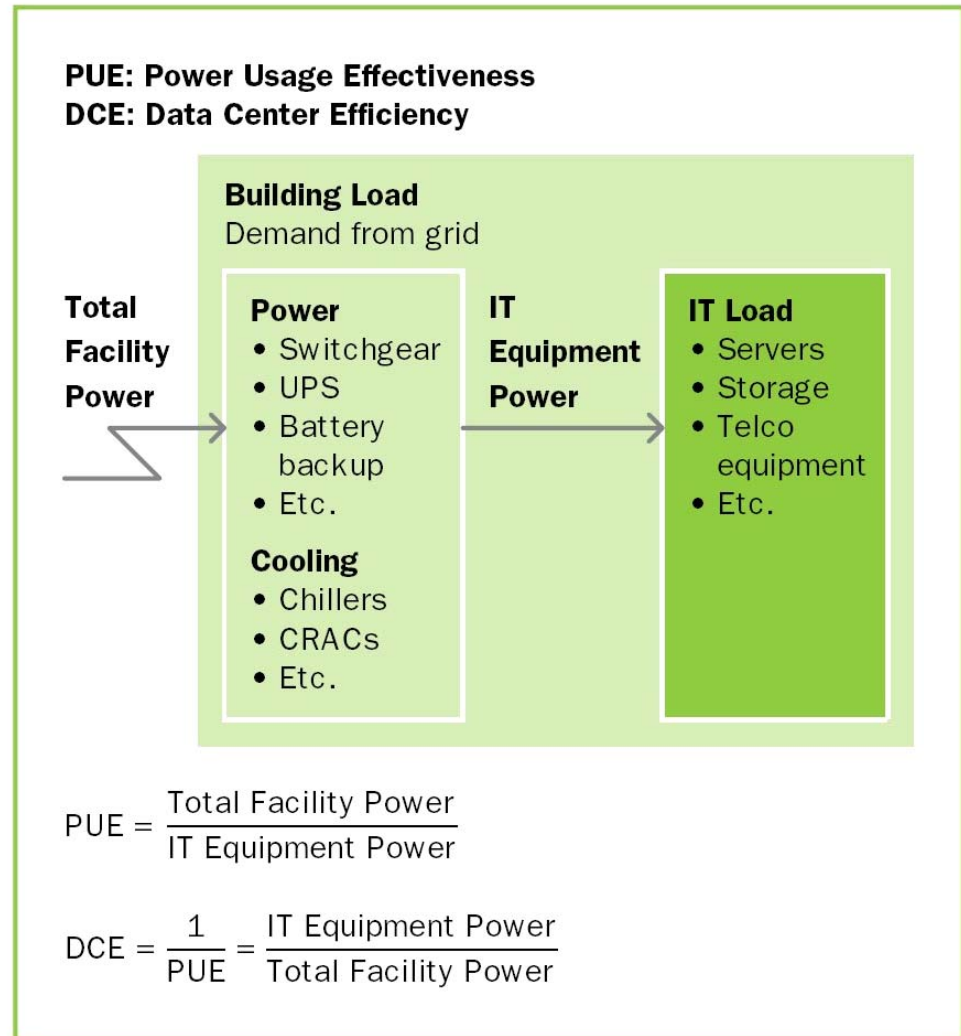
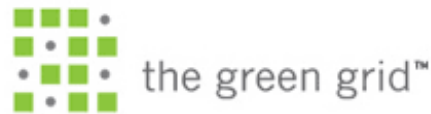
- Improve Power Conversion & Distribution Efficiency in the Data Center
 - Distribute Higher Voltages Directly to the IT Equipment Cabinets
 - 400-480 VAC directly from the output of the building transformer
 - 400-600 VDC directly from the output of a UPS without the inverter stage
 - No on Floor Step Down Transformers
 - Assure Low Loss in Power Distribution Cabling .
 - Use efficient building transformers (98.5%) and efficient UPS's (94% AC output / 97% DC output). Assure efficiency at actual normal operating load.

Potential Future Directions to Improve Data Center Efficiency

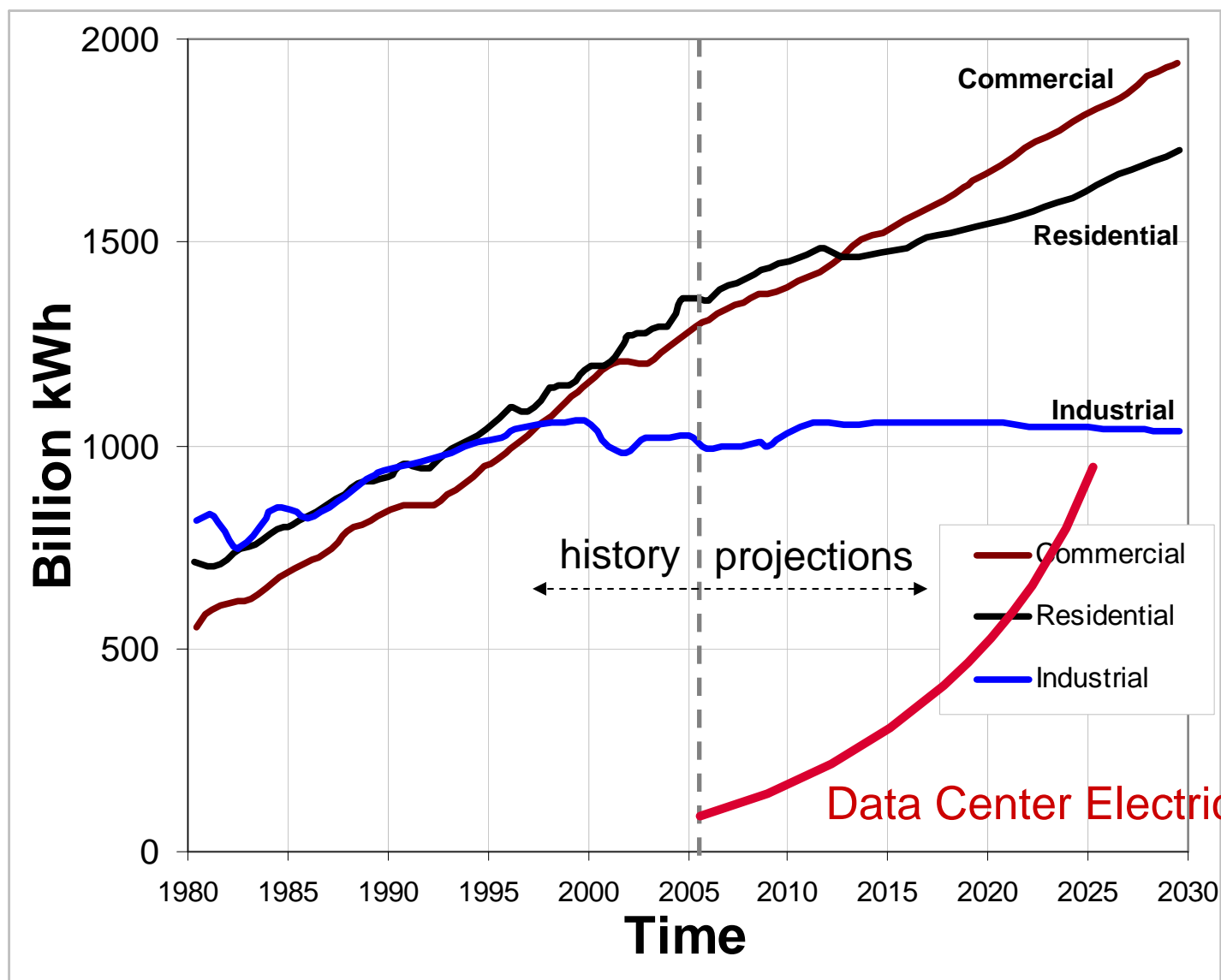
- Provide Customer Choice in Input Operating Voltage
 - 200-480 VAC 3-phase nominal & 400-600VDC, Enhanced Universal Input
 - Configurations may be limited for 200-240 VAC input on the largest systems
 - 277 VAC add to smaller equipment; enables 480V phase-to-neutral operation
 - Attempt to enable best operating efficiency for each customer

- Design IT Equipment Power & Cooling for True End-to-End Efficiency
 - Power efficiency optimization from 13KV all the way to 1V
 - 13KV to the IT equipment input (PUE) is not a complete metric
 - Cooling efficiency from the outside ambient all the way to the silicon junction
 - Lower Temperature CMOS silicon dissipates less power
 - Electronics packed closer together may dissipate less power

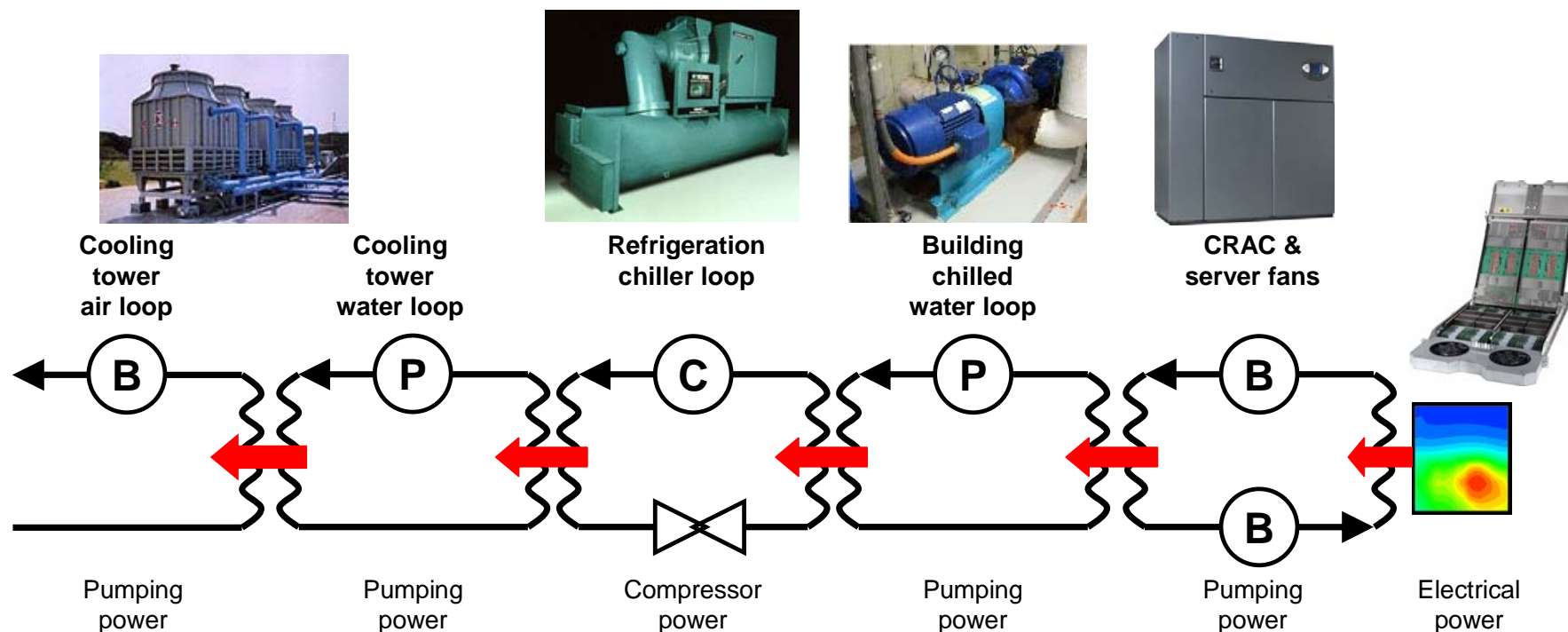
Data Center Energy Efficiency Metric



Delivered Annual electricity consumption by sector, 1980-2030



Data Center Infrastructure





IT Equipment is HOT...And HEAVY



P – Series 595
 31"W x 66"D x 80"H
77500 BTU
3014 Lbs

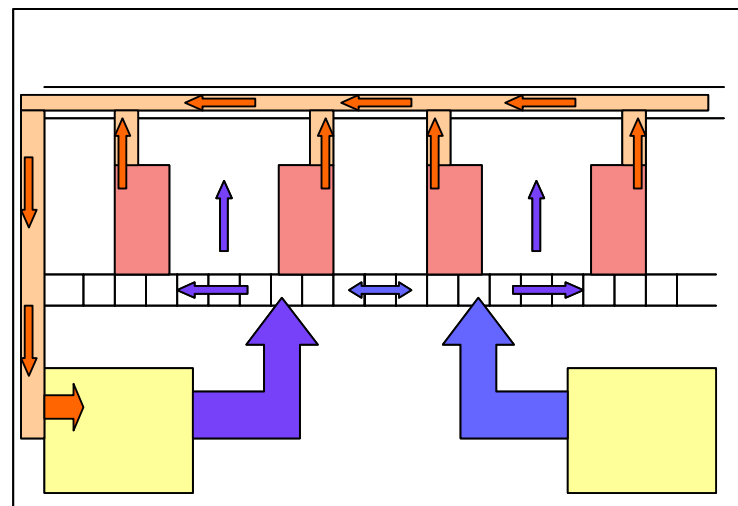
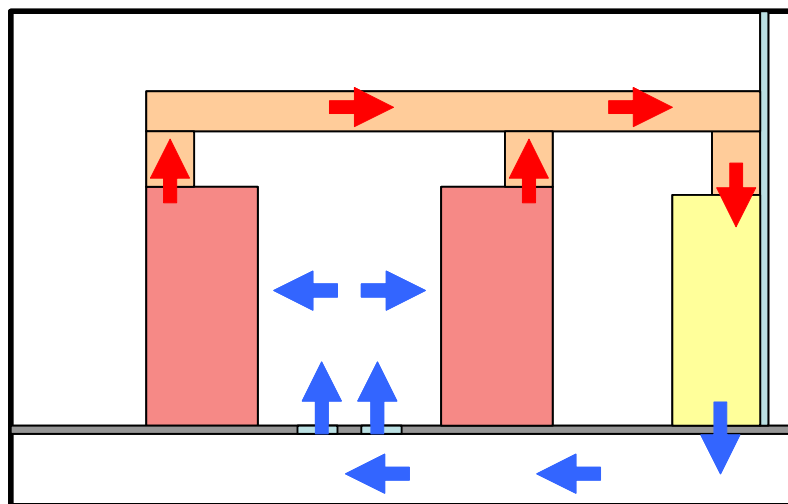
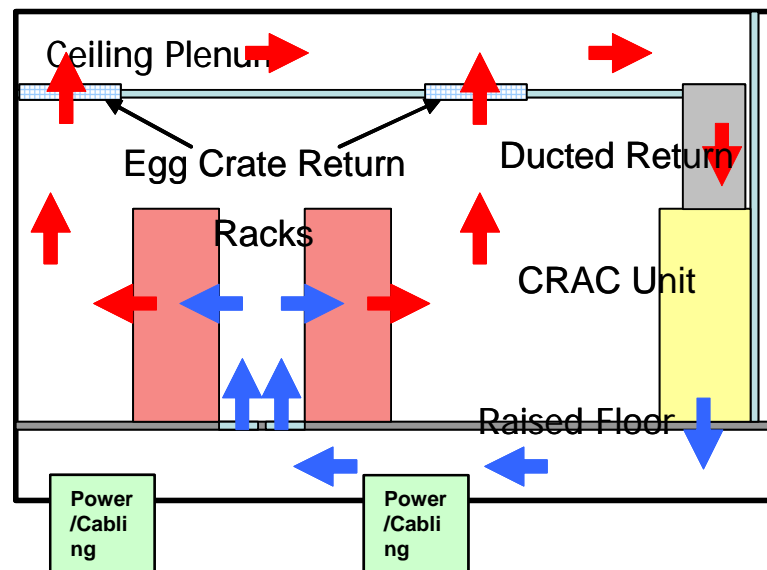
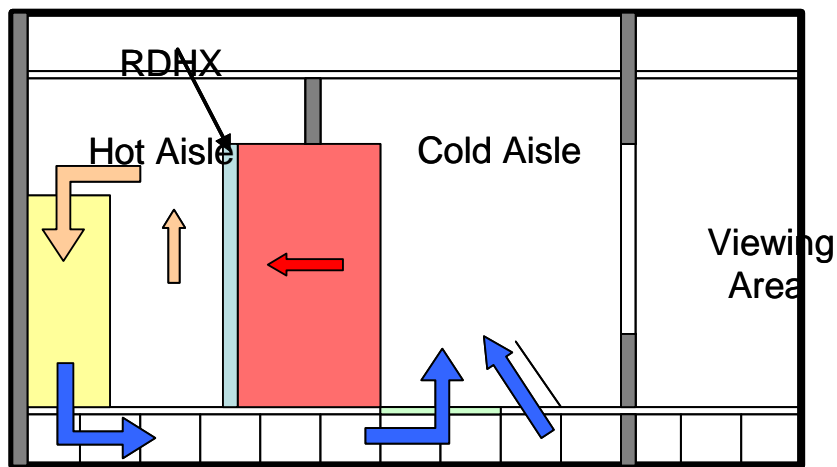


3276 Lbs

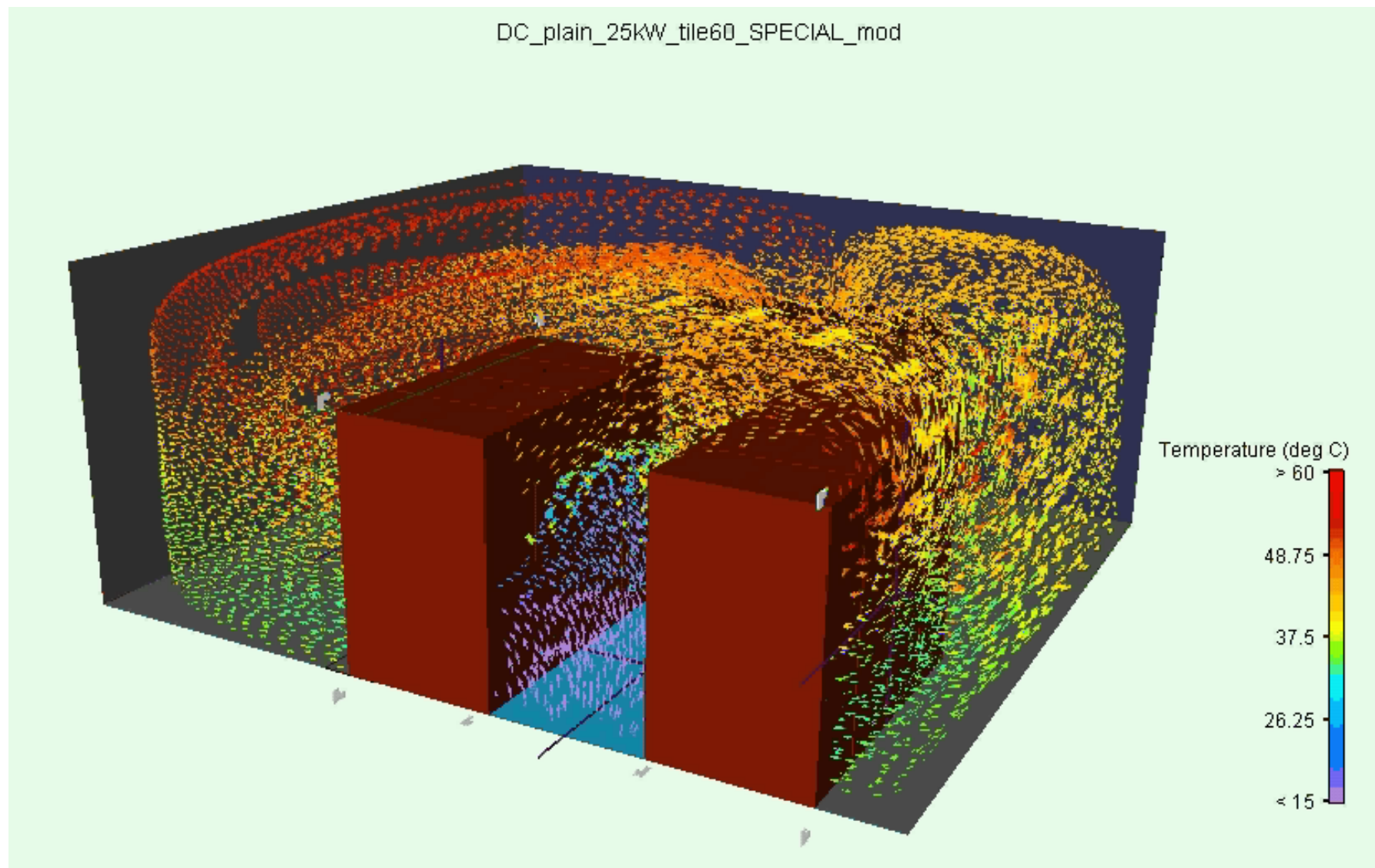


P-Series 690
 62" W x 50" D x 80"H
108,000 BTU
4233 Lbs

Possible Ventilation Schemes



Hot Air Recirculation Animation - Raised Floor



Summary

- ✓ Liquid cooling is back – improves overall energy efficiency
- ✓ Integrate functions more effectively to drive efficiency
- ✓ Viewing designs more holistically – end to end power and cooling solutions

Thank You